

# SI5312-H / SI5312-H(B)

IRED

#### **Features**

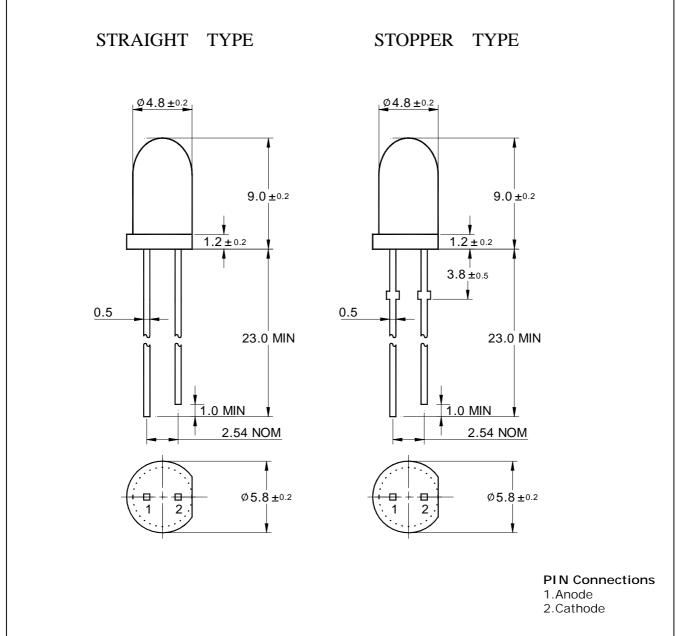
- Colorless transparency lens type
- φ5mm(T-13/4) all plastic mold type
- Low power consumption
- High radiant intensity

#### **Applications**

• Infrared remote control and free air transmission systems with low forward voltage and comfortable radiation angle requirements in combination with PIN photodiodes or phototransistors.

#### **Outline Dimensions**

unit: mm



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### **Absolute maximum ratings**

Characteristic	Symbol	Ratings	Unit		
Power Dissipation	$P_{D}$	150	mW		
Forward Current	I <sub>F</sub>	100	mA		
*1Peak Forward Current	I <sub>FP</sub>	1	А		
Reverse Voltage	$V_R$	4	V		
Operating Temperature	T <sub>opr</sub>	-25 85			
Storage Temperature	T <sub>stg</sub>	-30 100			
* <sup>2</sup> Soldering Temperature	T <sub>sol</sub>	260 for 5 seconds			

<sup>\*1.</sup>Duty ratio = 1/16, Pulse width = 0.1ms

### **Electrical Characteristics**

Characteristic	Symbol	Test Condition	Min.	Typ.	Max.	Unit
Forward Voltage	$V_{F}$	I <sub>F</sub> = 50mA	-	1.3	1.7	V
Radiant Intensity	Ι <sub>Ε</sub>	I <sub>F</sub> = 50mA	30	70	-	mW/Sr
Peak Wavelength	$\lambda_{ m P}$	I <sub>F</sub> = 50mA	-	950	-	nm
Spectrum Bandwidth		I <sub>F</sub> = 50mA	-	50	-	nm
Reverse Current	$I_R$	$V_R = 4V$	-	-	10	uA
* <sup>3</sup> Half angle	$\theta^1/_2$	I <sub>F</sub> = 50mA	-	±8	-	deg

<sup>\*3.</sup>  $\theta$ 1/2 is the off-axis angle where the luminous intensity is 1/2 the peak intensity

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<sup>\*2.</sup>Keep the distance more than 2.0mm from PCB to the bottom of IRED package

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### **Characteristic Diagrams**

Fig. 1  $I_F$  -  $V_F$ 

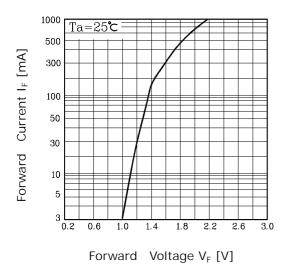
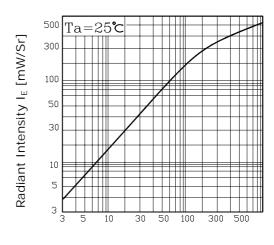
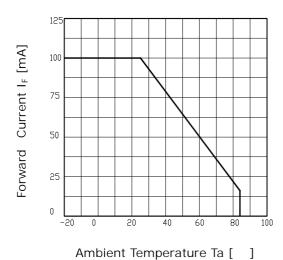


Fig. 2  $I_E$  -  $I_F$ 



Forward Current I<sub>F</sub> [mA]

Fig.  $3 I_F - Ta$ 



**Fig.4 Spectrum Distribution** 

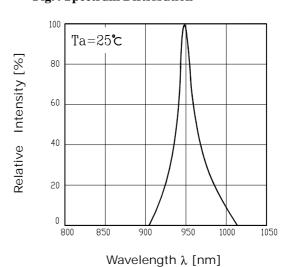
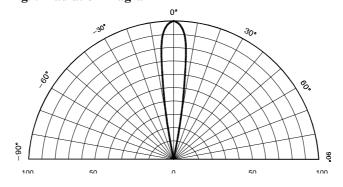


Fig. 5 Radiation Diagram



Relative Radiant Intensity I<sub>E</sub> [%]

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